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STP16CPC26PTR

STMicroelectronics

LED Display Drivers LV 16-bit LED Driver 5mA to 90mA 30MHz

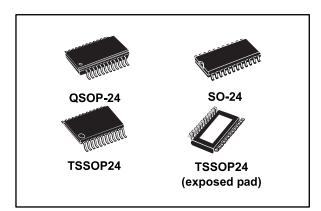
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STP16CPC26



Low voltage 16-bit constant current LED sink driver

Datasheet - production data



Features

- 16 constant current output channels
- Adjustable output current through external resistor
- Output current: 5 mA to 90 mA
- ±1% typical current accuracy bit to bit
- Max clock frequency: 30 MHz
- 20 V current generators rated voltage
- 3 5.5 V power supply
- Thermal shutdown for overtemperature protection

Description

The STP16CPC26 is a monolithic, low voltage, 16-bit constant current LED sink driver. The device contains a 16-bit shift register and data latches, which convert serial input data into parallel output format. In the output stage sixteen regulated current generators provide 5 mA to 90 mA constant current to drive LEDs. The current is externally adjusted through a resistor. LED brightness can be adjusted from 0% to 100% via OE pin.

The STP16CPC26 guarantees a 20 V driving capability, allowing users to connect more LEDs in series to each current source.

The high 30 MHz clock frequency makes the device suitable for high data rate transmission.

The thermal shutdown (170 °C with about 15 °C hysteresis) assures protection from overtemperature events.

The STP16CPC26 is housed in four different packages: QSOP24, SO-24, TSSOP-24 and HTSSOP-24 (with exposed pad).

Applications

- Video display panel LED driver
- Special lighting

Table 1: Device summary

Order code	Package	Packing
STP16CPC26MTR	SO-24	1000 parts per reel
STP16CPC26TTR	TSSOP24	2500 parts per reel
STP16CPC26XTR	TSSOP24 exposed pad	2500 parts per reel
STP16CPC26PTR	QSOP-24	2500 parts per reel

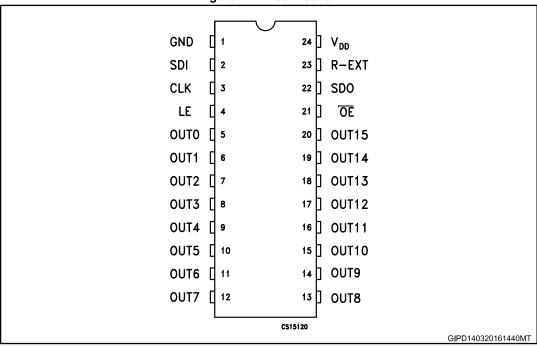
Contents

1	Pin desc	cription	3
2	Electrica	al ratings	4
	2.1	Absolute maximum ratings	4
	2.2	Thermal data	4
3	Electrica	al characteristics	5
4	Simplific	ed internal block diagram	8
5	Typical	application circuit	8
6		ent circuit and outputs	
7	-	test circuits	
8		diagrams	
9	•	generators characteristics	
	9.1	Current setting	
	9.2	Current accuracy	
	9.3	Generators voltage drop	
10	Therma	l shutdown	16
11	Package	e information	17
	11.1	QSOP-24 package information	
	11.2	SO-24 package information	20
	11.3	TSSOP24 package information	21
	11.4	TSSOP24 exposed pad package information	23
	11.5	TSSOP24, TSSOP24 exposed pad and	
		SO-24 packing information	25
12	Revisio	n history	27

STP16CPC26 Pin description

1 Pin description

Figure 1: Pin connection





The exposed-pad (if present) should be electrically connected to a metal land electrically isolated or connected to ground.

Table 2: Pin description

Pin n°	Symbol	Name and function
1	GND	Ground terminal
2	SDI	Serial data input terminal
3	CLK	Clock input terminal
4	LE	Latch input terminal
5-20	OUT 0-15	Output terminal
21	OE	Input terminal of output enable (active low)
22	SDO	Serial data out terminal
23	R-EXT	Input terminal for an external resistor for constant current programming
24	V_{DD}	Supply voltage terminal

Electrical ratings STP16CPC26

2 Electrical ratings

2.1 Absolute maximum ratings

Stressing the device above the rating listed in the "absolute maximum ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table	ე.	A booluse	maximum	***
i abie	J.	Absolute	maximum	ratinus

Symbol	Parameter	Value	Unit
V_{DD}	Supply voltage	0 to 7	V
Vo	Output voltage	-0.5 to 20	V
lo	Output current	90	mA
VI	Input voltage	-0.4 to V _{DD} +0.4	V
IGND	GND terminal current	1600	mA
ESD	Electrostatic discharge protection HBM human body model	±2	kV
fclk	Clock frequency	30	MHz

2.2 Thermal data

Table 4: Thermal data

Symbol	Parameter	Value	Unit		
T _A	Operating free-air temperature range		-40 to +125	°C	
T _{OPR}	Operating temperature range	Operating temperature range			
T _{STG}	Storage temperature range	-55 to +150	°C		
		SO-24	60	°C/W	
	Thermal resistance junction-ambient ⁽¹⁾	TSSOP24	85	°C/W	
R _{thJA}		TSSOP24 (2) exposed pad	37.5	°C/W	
		QSOP-24	72	°C/W	

Notes:

⁽¹⁾ According with JEDEC standard 51-7.

⁽²⁾ The exposed pad should be soldered directly to the PCB to realize the thermal benefits.

3 Electrical characteristics

 $V_{DD} = 3.3 \text{ V} - 5 \text{ V}, T_A = 25 ^{\circ}\text{C}, \text{ unless otherwise specified.}$

Table 5: Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{dd}	Supply voltage		3		5.5	
V _{IH}	Input voltage high level		0.8*Vdd	-	Vdd	V
V _{IL}	Input voltage low level		GND	-	0.2*Vdd	V
Vol	Serial data output voltage	I _{OH} = - 1 mA	-	-	0.4	
Vон	(SDO) ⁽¹⁾	I _{OL} = + 1 mA	V _{DD} -0.4	-	-	
Іон	Output leakage current	Vo = 20 V, Outn = OFF	-	-	0.5	μΑ
Δl _{OL1}	Current accuracy	Vds = 0.3 V, R _{EXT} = 900 W, I _{OL} = 22 mA	-	±1	±3	0/
Δl _{OL2}	channel to channel (2)(3)	Vds = 0.6 V, R _{EXT} = 360 W, I _{OL} = 55 mA	-	±1	±3	%
DI _{OL3}	Current accuracy	Vds = 0.3 V, R _{EXT} = 900 W, I _{OL} = 22 mA	-	-	±6	0/
∆l _{OL4}	device to device (2)	Vds = 0.6 V, REXT = 360 W, IoL = 55 mA	-	-	±6	%
R _{IN(up)}	Pull-up resistor for OE pin		250	500	800	101
R _{IN(down)}	Pull-down resistor for LE pin		250	500	800	KW
IDD(OFF1)		R _{EXT} = OPEN OUT 0 to 15 = OFF	-	3	7	
IDD(OFF2)	Supply current (OFF)	R _{EXT} = 900 W OUT 0 to 15 = OFF	-	7	10	mA
IDD(OFF3)		R _{EXT} = 360 W OUT 0 to 15 = OFF	-	11	13.5	
IDD(ON1)	Supply ourront (ONI)	R _{EXT} = 900 W OUT 0 to 15 = ON	-	7	11	
IDD(ON2)	Supply current (ON)	R _{EXT} = 360 W OUT 0 to 15 = ON	-	11	15	
%/dV _{DS}	Output current vs. output voltage regulation	V _{DS} from 1.0 V to 3.0 V Io = 22 mA Io = 55 mA	-	±0.1	-	%/V

Electrical characteristics

STP16CPC26

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
%/dV _{DD}	Output current vs. supply voltage regulation (4)	Io = 22 mA; V _{DS} = 0.3 V Io = 55 mA; V _{DS} = 0.6 V	-	±1	-	%/V
Tsd	Thermal shutdown		-	170	-	°C
Tsd-hy	Thermal shutdown hysteresis (4)		-	15	20	

Notes:

 $^{^{(1)}}$ Specification referred to TJ from -40 °C to +125 °C. Specification over the -40 to +125 °C TJ temperature range are assured by design, characterization and statistical correlation.

⁽²⁾ Tested with just one output ON.

 $^{^{(3)}}$ $\Delta_{IOL+} = ((I_{OLmax} - I_{OLmean}) / I_{OLmean}) + 100$, $D_{IOL-} = ((I_{OLmin} - I_{OLmean}) / I_{OLmean}) + 100$, where $I_{OLmean} = (I_{OLout1} + I_{OLout2} + ... + I_{OLout16}) / 16$.

⁽⁴⁾ Guaranteed by design.

 V_{DD} = 3.3 V - 5 V, T_j = 25 °C, unless otherwise specified.

Table 6: Switching characteristics

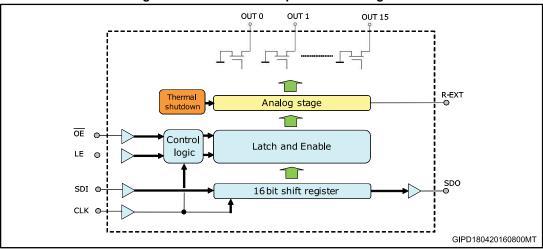
Symbol		Parameter	Condition	Conditions		Тур.	Max.	Unit
f _{clk}	Cl	ock frequency			-	-	30	MHz
t _{PLH1}	CLK - OUTn				-	100	-	
t _{PLH2}	LE - OUTn				-	100	-	
t _{PLH3}	OE – OUTn	Propagation delay time ("L" to "H")			-	100	-	
t _{PLHa}	CLK CDO	((((((((((((((((((((VDD = 3.3 V	-	30	-	
t _{PLHb}	CLK - SDO			VDD = 5 V	-	20	-	
t _{PHL1}	CLK - OUTn	Propagation delay time ("H" to "L")			-	28	-	
t _{PHL2}	LE - OUTn		.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		-	28	-	
t _{PHL3}	OE – OUTn		VDS = 0.8 V VIH = VDD		-	25	-	
t _{PHLa}	011/ 000		VII = VDD VIL = GND	VDD = 3.3 V	-	30	-	
t PHLb	CLK - SDO		R _{EXT} = 900 Ω	VDD = 5 V	-	20	-	
tw(CLK)	CLK	Pulse width	RL = 50 Ω		20	-	-	
t _{w(L)}	LE		CL = 10 pF		20	-	-	
t _{w(OE)}	OE				150	-	-	
t _{su(L)}	Se	tup time for LE			5	-	-	
t _{h(L)}	Но	old time for LE			5	-	-	ns
t _{su(D)}	Set	up time for SDI			5	-	-	
t _{h(D)}	Но	ld time for SDI			10	-	-	
tr ⁽¹⁾	Maxim	num CLK rise time			-	-	5000	
tf ⁽¹⁾	Maxin	num CLK fall time			-	-	5000	
t _{or1a}	Outpu	t rise time of Vout	VIH = VDD,	VDD = 3.3 V	-	95	-	
t _{or1b}	Outpu	t rise time of Vout	VIL = GND	VDD = 5 V	-	85	-	
t _{of1a}	Outpu	t fall time of Vout	VDS = 0.8 V, RL = 50 Ω	VDD = 3.3 V	-	40	-	
t _{of1b}	Output fall time of Vout		CL = 10 pF lout = 22 mA	VDD = 5 V	-	25	-	
t _{or2a}	Outpu	t rise time of Vout	VIH = VDD,	VDD = 3.3 V	-	80	-	
t _{or2b}	Output rise time of Vout		VIL = GND	VDD = 5 V	-	70	-	
t _{of2a}	Output fall time of Vout		VDS = 0.8 V	VDD = 3.3 V	-	40	-	
t _{of2b}	Output fall time of Vout		RL = 50 Ω CL = 10 pF lout = 55 mA	VDD = 5 V	-	30	-	
I _{out-ov}	Output current turn-on overshoot		VDS = 0.6 to 3V CL = 10 pF lout = 5 to 60 mA		-	-	0	%

Notes:

⁽¹⁾If devices are connected in cascade and tr or tf is large, it may be critical to achieve the timing required for data transfer between two cascaded devices.

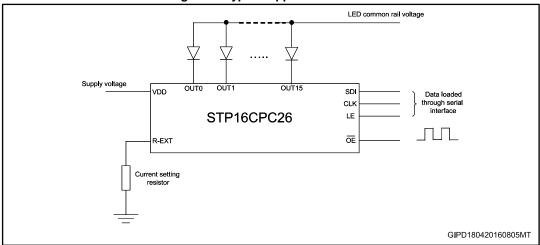
4 Simplified internal block diagram

Figure 2: STP16CPC26 simplified block diagram



5 Typical application circuit

Figure 3: Typical application circuit



6 Equivalent circuit and outputs

Figure 4: OE terminal

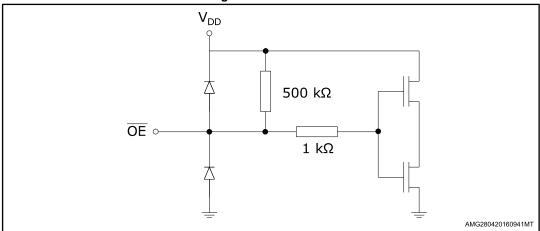


Figure 5: LE terminal

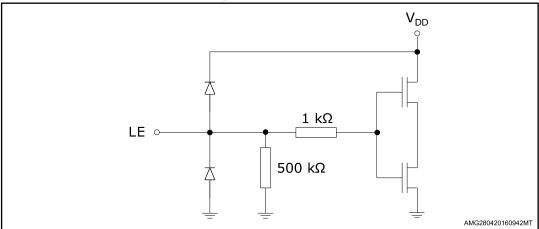


Figure 6: CLK, SDI terminal

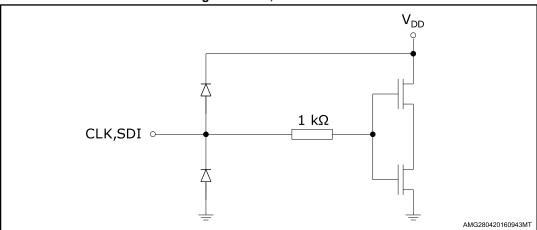
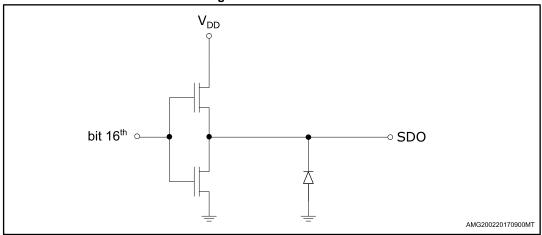


Figure 7: SDO terminal



STP16CPC26 Typical test circuits

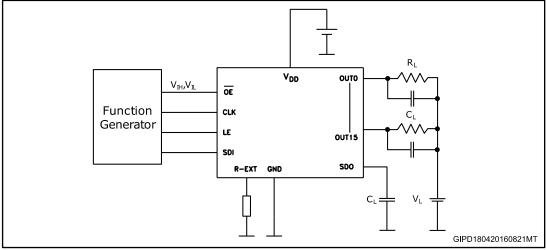
7 Typical test circuits

Figure 8: "Typical test circuit for electrical characteristics" and Figure 9: "Typical test circuit for switching characteristics" show respectively the typical test circuit used measuring electrical (e.g. input voltage high/low level, output leakage current, supply current, etc.) and switching characteristics (propagation delays, set-up and hold time, rise and fall time of Vout, etc.). The resistor R_L and capacitor C_L in parallel connected to each output in Figure 8: "Typical test circuit for electrical characteristics" simulate a LED behavior.

I_{DD} ↓ loL V_{DD} ŌE CLK LE OUT 15 R-EXT GND I_{REF} ↓ GIPD180420160819MT

Figure 8: Typical test circuit for electrical characteristics





Timing diagrams STP16CPC26

8 Timing diagrams

The timing diagram shown in *Figure 10: "Timing diagram"* and the truth table in *Table 7: "Truth table"* explain how to send data to the device. This can be summarized in the following points:

- LE and OE are level sensitive and not synchronized with the CLK signal
- When LE is at low level, the latch circuit holds previous data
- If LE is high level, data present in the shift register are latched
- When $\overline{\text{OE}}$ is at low level, the status of the outputs OUT0 to OUT15 depends on the data in the latch circuits
- With OE at high level, all outputs are switched off independently on the data stored in the latch circuits
- Every rising edge of the CLK signal, a new data on SDI pin is sampled. This data is loaded into the shift register, whereas a bit is shifted out from SDO

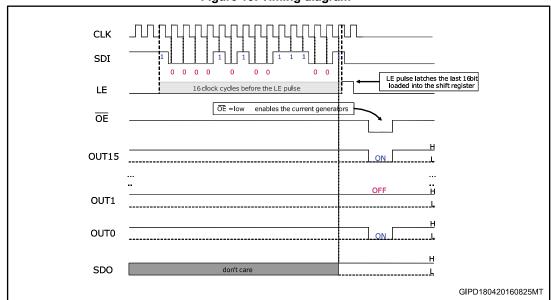


Figure 10: Timing diagram

Table 7: Truth table

Clock	LE	OE	Serial-IN	OUT0OUT7 OUT15 (1)	SDO
_ -	Н	L	Dn	Dn Dn - 7 Dn -15	Dn - 15
_ _	L	L	Dn + 1	No change	Dn - 14
_ -	Н	L	Dn + 2	Dn + 2 Dn - 5 Dn -13	Dn - 13
- _	Χ	L	Dn + 3	Dn + 2 Dn - 5 Dn -13	Dn - 13
- _	Х	Н	Dn + 3	OFF	Dn - 13

Notes:

 $^{(1)}$ OUTn = ON when Dn = H, OUTn = OFF when Dn = L.

STP16CPC26 Timing diagrams

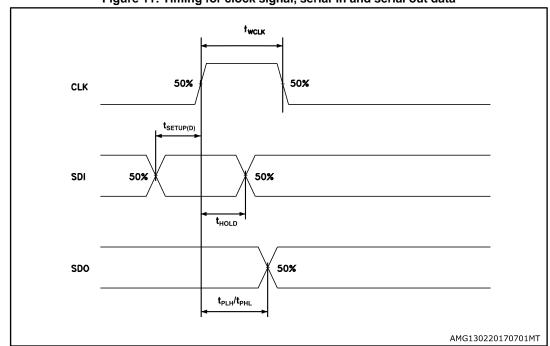
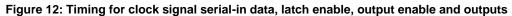


Figure 11: Timing for clock signal, serial-in and serial out data

The correct sampling of the data depends on the stability of the data at SDI on the rising edge of the clock signal and it is assured by a proper data setup and hold time (t_{SETUP1} And t_{HOLD}), as shown in *Figure 11: "Timing for clock signal, serial-in and serial out data"*. The same figure shows the propagation delay from CLK to SDO (t_{PLH}/t_{PHL}). *Figure 12: "Timing for clock signal serial-in data, latch enable, output enable and outputs"* describes the setup times for LE and \overline{OE} signals (t_{SETUP2} and t_{SETUP3} respectively), the minimum duration of these signals (t_{WLAT} and t_{WENA} respectively) and the propagation delay from CLK to OUTn, LE to OUTn and \overline{OE} to OUTn (t_{PLH1}/t_{PHL1} , t_{PLH2}/t_{PHL2} and t_{PLH3}/t_{PHL3} respectively). Finally *Figure 13: "Outputs"* defines the turn-on and turn-off time (t_r and t_f) of the current generators.

Timing diagrams STP16CPC26



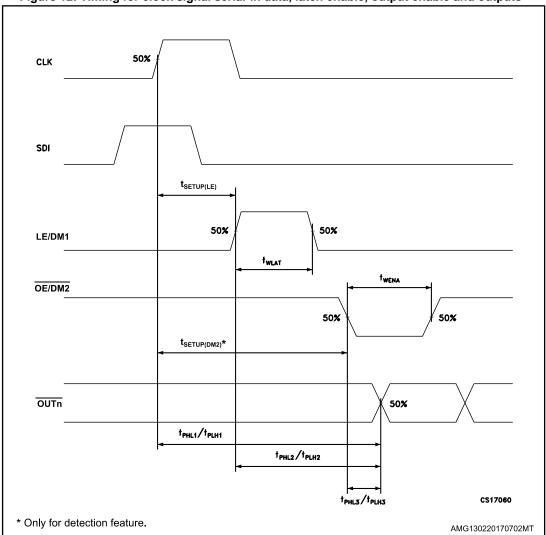
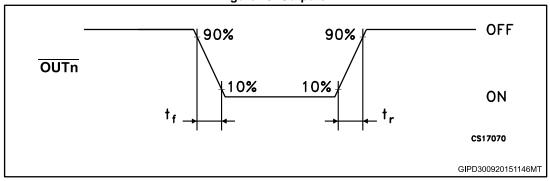


Figure 13: Outputs



9 Current generators characteristics

9.1 Current setting

The current of all outputs is programmed through an external resistor connected to R-EXT pin, as shown in *Figure 14: "Resistor for current programming"*. The curve in *Figure 15: "Output current vs R-EXT resistor"* describes the relation between the current and the resistor connected to R-EXT pin, whereas the *Table 8: "Recommended values of Rext for some output current value"* shows how to set some typical current values.

Figure 14: Resistor for current programming

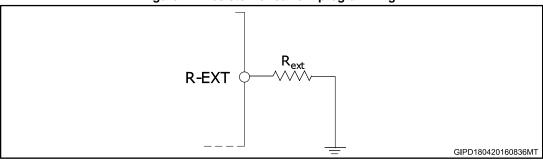


Figure 15: Output current vs R-EXT resistor

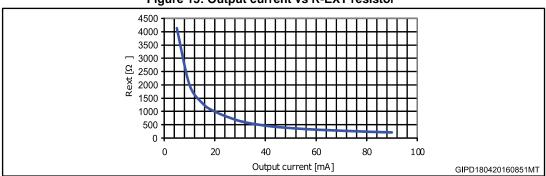


Table 8: Recommended values of Rext for some output current value

·					
Output current [mA]	R _{ext} [Ω]	Closer standard value (E24 series) [Ω]			
5	4129	4300			
10	2005	200			
20	999	1000			
40	471	470			
60	322	330			
90	217	220			

9.2 Current accuracy

A typical current accuracy of $\pm 1\%$ ($\pm 3\%$ maximum) between channels is guaranteed at 22 mA and 55 mA output current (refer to *Table 6: "Switching characteristics"*) and $\pm 6\%$ (maximum) current accuracy between ICs.



Thermal shutdown STP16CPC26

9.3 Generators voltage drop

In order to correctly regulate the current, a minimum dropout voltage must be assured across the current generators.

Figure 16: "Dropout voltage vs output current" and Table 9: "Dropout voltage vs output current" provides just an indicative idea about the dropout voltage to assure over the current range. However it is recommended to use value of V_{DROP} slightly higher than those indicated in Figure 16: "Dropout voltage vs output current" and Table 9: "Dropout voltage vs output current".

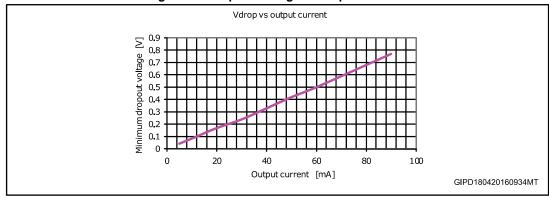


Figure 16: Dropout voltage vs output current

Table 9: Dropout voltage vs output current

Output current [mA]	V _{DROP} @ 3.3 V [mV]	V _{DROP} @ 5 V [mV]
5	44	44
10	85	85
20	170	170
40	350	330
60	530	500
90	820	770

10 Thermal shutdown

The STP16CPC26 is featured with a thermal shutdown. This protection is triggered if the junction temperature reaches 170 °C. When the thermal shutdown is activated, all outputs are turned off independently on the data latched. Once the temperature decreases (thermal shutdown hysteresis is typically 15 °C), the outputs are enabled again and the device keeps on working.

Once the temperature decreases (thermal shutdown hysteresis is typically 15°C), the outputs are enabled again and the device keeps on working.

STP16CPC26 Package information

11 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

11.1 QSOP-24 package information

Figure 17: QSOP-24 package outline

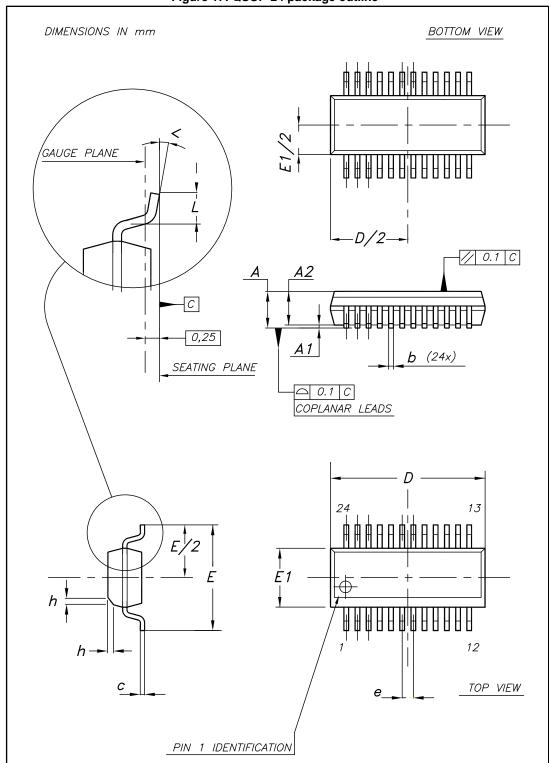


Table 10: QSOP-24 mechanical data

Dim.	mm		
	Min.	Тур.	Max.
А	1.54	1.62	1.73
A1	0.10	0.15	0.25
A2		1.47	
b	0.20		0.31
С	0.17		0.254
D	8.56	8.66	8.76
Е	5.80	6.00	6.20
E1	3.80	3.91	4.01
е		0.635	
L	0.40	0.635	0.89
h	0.25	0.33	0.41
<	0°		8°

11.2 SO-24 package information

Figure 18: SO-24 package outline

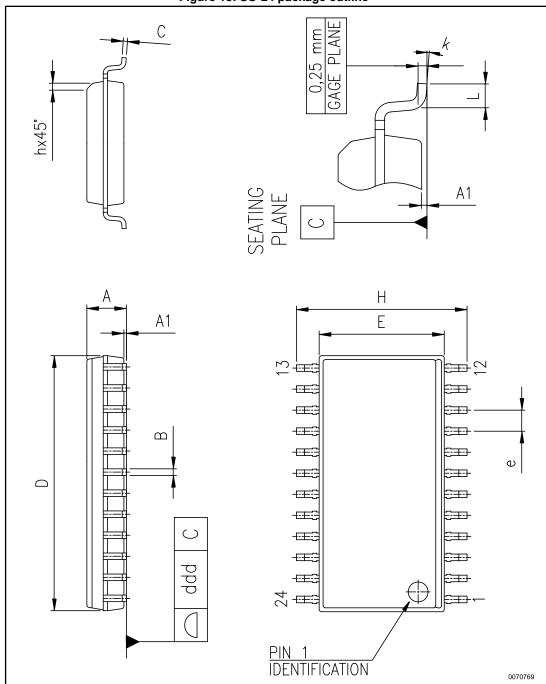
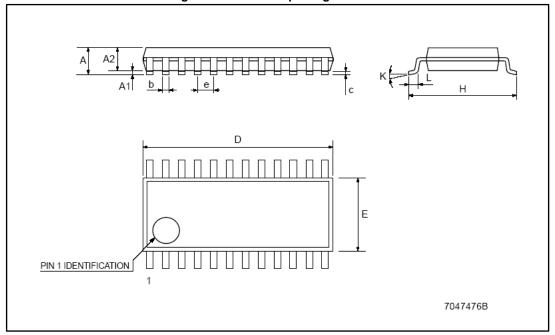


Table 11: SO-24 mechanical data

Dim.	mm		
	Min.	Тур.	Max.
А	2.35		2.65
A1	0.10		0.30
В	0.33		0.51
С	0.23		0.32
D	15.20		15.60
E	7.40		7.60
е		1.27	
Н	10.00		10.65
h	0.25		0.75
L	0.40		1.27
k	0		8
ddd			0.10

11.3 TSSOP24 package information

Figure 19: TSSOP24 package outline



22/28

Table 12: TSSOP24 mechanical data

Dim.	mm		
	Min.	Тур.	Max.
А			1.1
A1	0.05		0.15
A2		0.9	
b	0.19		0.30
С	0.09		0.20
D	7.7		7.9
Е	4.3		4.5
е		0.65 BSC	
Н	6.25		6.5
K	0°		8°
L	0.50		0.70

STP16CPC26 Package information

11.4 TSSOP24 exposed pad package information

Figure 20: TSSOP24 exposed pad package outline

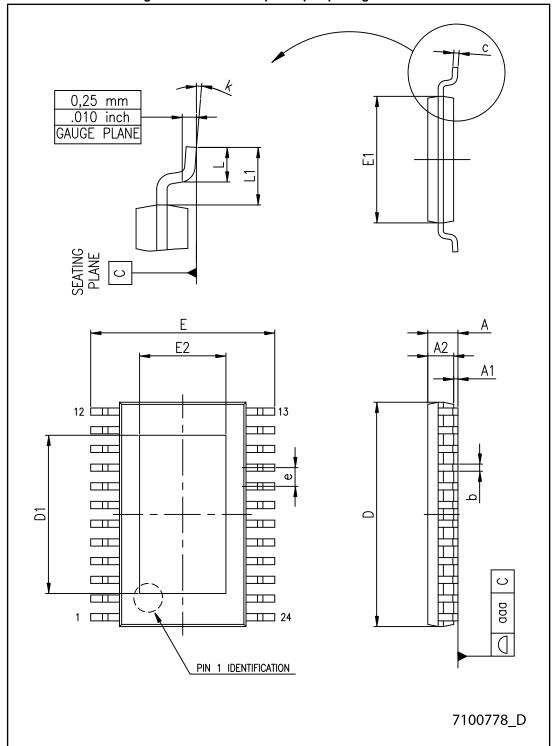


Table 13: TSSOP24 exposed pad mechanical data

Dim.	mm		
	Min.	Тур.	Max.
А			1.20
A1			0.15
A2	0.80	1.00	1.05
b	0.19		0.30
С	0.09		0.20
D	7.70	7.80	7.90
D1	4.80	5.00	5.2
Е	6.20	6.40	6.60
E1	4.30	4.40	4.50
E2	3.00	3.20	3.40
е		0.65	
L	0.45	060	075
L1		1.00	
k	0°		8°
aaa			0.10

STP16CPC26 Package information

11.5 TSSOP24, TSSOP24 exposed pad and SO-24 packing information

Figure 21: TSSOP24, TSSOP24 exposed pad and SO-24 reel outline

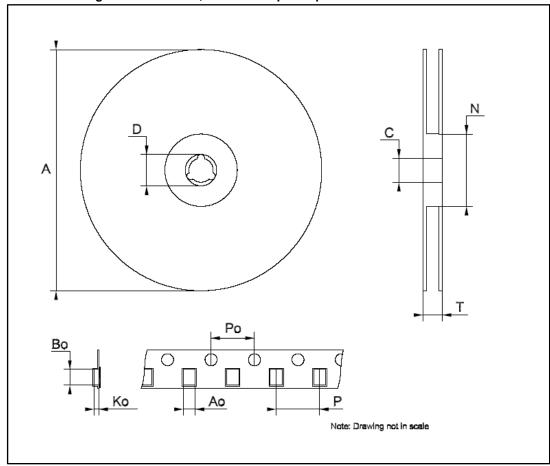


Table 14: TSSOP24 and TSSOP24 exposed pad tape and reel mechanical data

Dim.	mm		
	Min.	Тур.	Max.
А		-	330
С	12.8	-	13.2
D	20.2	-	
N	60	-	
Т		-	22.4
Ao	6.8	-	7
Во	8.2	-	8.4
Ko	1.7	-	1.9
Po	3.9	-	4.1
Р	11.9	-	12.1

Table 15: SO-24 tape and reel mechanical data

Dim.	mm		
	Min.	Тур.	Max.
А		-	330
С	12.8	-	13.2
D	20.2	-	
N	60	-	
Т		-	30.4
Ao	10.8	-	11.0
Во	15.7	-	15.9
Ко	2.9	-	3.1
Po	3.9	-	4.1
Р	11.9	-	12.1

STP16CPC26 Revision history

12 Revision history

Table 16: Document revision history

Date	Revision	Changes
04-Mar-2011	1	First release
05-Apr-2011	2	Updated Table 6
19-Jul-2012	3	Updated Table 7.
19-Jul-2012	4	Updated characteristics in Table 5: Electrical characteristics and Table 6: Switching characteristics. Minor text changes.
1-Jun-2014	5	Updated template and value Table 13: TSSOP24 exposed pad mechanical data.
13-Apr-2017	6	Updated Figure 11: "Timing for clock signal, serial-in and serial out data" and Figure 12: "Timing for clock signal serial-in data, latch enable, output enable and outputs", Section 11.1: "QSOP-24 package information". Minor text changes.

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